

MC74VHCT74A

Dual D-Type Flip-Flop with Set and Reset

The MC74VHCT74A is an advanced high speed CMOS D-type flip-flop fabricated with silicon gate CMOS technology. It achieves high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

The signal level applied to the D input is transferred to Q output during the positive going transition of the Clock pulse.

Reset ($\overline{RD}$) and Set ($\overline{SD}$) are independent of the Clock (CP) and are accomplished by setting the appropriate input Low.

The internal circuit is composed of three stages, including a buffer output which provides high noise immunity and stable output. The inputs tolerate voltages up to 7.0 V, allowing the interface of 5.0 V systems to 3.0 V systems.

The VHCT inputs are compatible with TTL levels. This device can be used as a level converter for interfacing 3.3 V to 5.0 V, because it has full 5.0 V CMOS level output swings.

The VHCT74A input structures provide protection when voltages between 0 V and 5.5 V are applied, regardless of the supply voltage. The output structures also provide protection when $V_{CC} = 0$ V. These input and output structures help prevent device destruction caused by supply voltage – input/output voltage mismatch, battery backup, hot insertion, etc.

Features

- High Speed: $f_{max} = 60$ MHz (Typ) at $V_{CC} = 5.0$ V
- Low Power Dissipation: $I_{CC} = 2$ μ A (Max) at $T_A = 25^\circ$ C
- Power Down Protection Provided on Inputs
- Balanced Propagation Delays
- Designed for 4.5 V to 5.5 V Operating Range
- Low Noise: $V_{OLP} = 0.8$ V (Max)
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 300 mA
- ESD Performance: HBM > 2000 V; Machine Model > 200 V
- Chip Complexity: 128 FETs or 32 Equivalent Gates
- Pb-Free Packages are Available

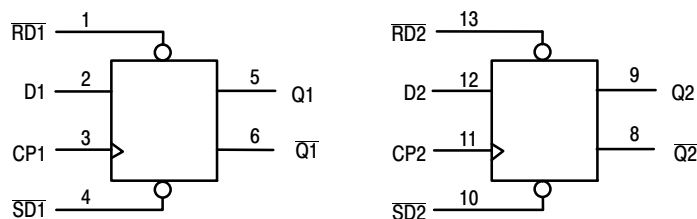


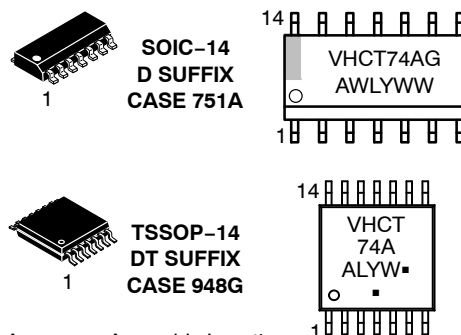
Figure 2. Logic Diagram



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MARKING DIAGRAMS



A = Assembly Location
WL, L = Wafer Lot
Y = Year
WW, W = Work Week
G or ■ = Pb-Free Package
(Note: Microdot may be in either location)

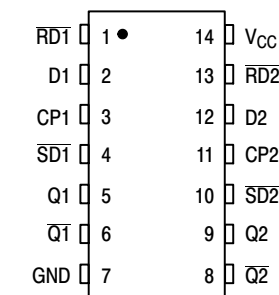


Figure 1. Pin Assignment

FUNCTION TABLE

Inputs				Outputs	
SD	RD	CP	D	Q	Q̄
L	H	X	X	H	L
H	L	X	X	L	H
L	L	X	X	H*	H*
H	H	↗	H	H	L
H	H	↘	L	L	H
H	H	L	X	No Change	No Change
H	H	H	X	No Change	No Change
H	H	↔	X	No Change	No Change

*Both outputs will remain high as long as Set and Reset are low, but the output states are unpredictable if Set and Reset go high simultaneously.

ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

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MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage	-0.5 to + 7.0	V
V_{in}	DC Input Voltage	-0.5 to + 7.0	V
V_{out}	DC Output Voltage $V_{CC} = 0$ High or Low State	-0.5 to + 7.0 -0.5 to $V_{CC} + 0.5$	V
I_{IK}	Input Diode Current	-20	mA
I_{OK}	Output Diode Current ($V_{OUT} < GND$; $V_{OUT} > V_{CC}$)	± 20	mA
I_{out}	DC Output Current, per Pin	± 25	mA
I_{CC}	DC Supply Current, V_{CC} and GND Pins	± 50	mA
P_D	Power Dissipation in Still Air, SOIC Packages† TSSOP Package†	500 450	mW
T_{stg}	Storage Temperature	-65 to + 150	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

†Derating - SOIC Packages: - 7 mW/°C from 65° to 125°C
TSSOP Package: - 6.1 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V_{CC}	DC Supply Voltage	4.5	5.5	V
V_{in}	DC Input Voltage	0	5.5	V
V_{out}	DC Output Voltage $V_{CC} = 0$ High or Low State	0 0	5.5 V_{CC}	V
T_A	Operating Temperature	-55	+ 125	°C
t_r, t_f	Input Rise and Fall Time $V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$	0	20	ns/V

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Conditions	V_{CC} V	$T_A = 25^\circ\text{C}$			$T_A = -55 \text{ to } 125^\circ\text{C}$		Unit
				Min	Typ	Max	Min	Max	
V_{IH}	Minimum High-Level Input Voltage		4.5 to 5.5	2.0			2.0		V
V_{IL}	Maximum Low-Level Input Voltage		4.5 to 5.5			0.8		0.8	V
V_{OH}	Minimum High-Level Output Voltage $V_{in} = V_{IH}$ or V_{IL}	$I_{OH} = -50 \mu\text{A}$	4.5	4.4	4.5		4.4		V
		$I_{OH} = -8 \text{ mA}$	4.5	3.94			3.80		
V_{OL}	Maximum Low-Level Output Voltage $V_{in} = V_{IH}$ or V_{IL}	$I_{OL} = 50 \mu\text{A}$	4.5		0.0	0.1		0.1	V
		$I_{OL} = 8 \text{ mA}$	4.5			0.36		0.44	
I_{in}	Maximum Input Leakage Current	$V_{in} = 5.5 \text{ V}$ or GND	0 to 5.5			± 0.1		± 1.0	μA
I_{CC}	Maximum Quiescent Supply Current	$V_{in} = V_{CC}$ or GND	5.5			2.0		20.0	μA
I_{CCT}	Quiescent Supply Current	Per Input: $V_{IN} = 3.4 \text{ V}$ Other Input: V_{CC} or GND	5.5			1.35		1.50	mA
I_{OPD}	Output Leakage Current	$V_{OUT} = 5.5 \text{ V}$	0			0.5		5.0	μA

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AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 3.0\text{ns}$)

Symbol	Parameter	Test Conditions	$T_A = 25^\circ\text{C}$			$T_A = -55 \text{ to } 125^\circ\text{C}$		Unit
			Min	Typ	Max	Min	Max	
t_{PLH} , t_{PHL}	Maximum Propagation Delay, CP to Q or $\bar{Q}$	$V_{CC} = 5.0 \pm 0.5\text{V}$ $C_L = 15\text{ pF}$ $C_L = 50\text{ pF}$		5.8 6.3	7.8 8.8	1.0 1.0	9.0 10.0	ns
t_{PLH} , t_{PHL}	Maximum Propagation Delay, $\bar{SD}$ or $\bar{RD}$ to Q or $\bar{Q}$	$V_{CC} = 5.0 \pm 0.5\text{V}$ $C_L = 15\text{ pF}$ $C_L = 50\text{ pF}$		7.6 8.1	10.4 11.4	1.0 1.0	12.0 13.0	ns
f_{max}	Maximum Clock Frequency (50% Duty Cycle)	$V_{CC} = 5.0 \pm 0.5\text{V}$ $C_L = 15\text{ pF}$ $C_L = 50\text{ pF}$	100 80	160 140		80 65		MHz
C_{in}	Maximum Input Capacitance			4	10		10	pF

C _{PD}	Power Dissipation Capacitance (Note 1)	Typical @ 25°C, V _{CC} = 5.0 V	pF
		24	

1. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: $I_{CC(OPR)} = C_{PD} \cdot V_{CC} \cdot f_{in} + I_{CC}/2$ (per flip-flop). C_{PD} is used to determine the no-load dynamic power consumption; $P_D = C_{PD} \cdot V_{CC}^2 \cdot f_{in} + I_{CC} \cdot V_{CC}$.

TIMING REQUIREMENTS (Input $t_r = t_f = 3.0\text{ ns}$)

Symbol	Parameter	V_{CC} V	Guaranteed Limit		Unit
			$T_A = 25^\circ\text{C}$	$T_A = -55 \text{ to } 125^\circ\text{C}$	
t_w	Minimum Pulse Width, CP	5.0 ± 0.5	5.0	5.0	ns
t_w	Minimum Pulse Width, $\bar{RD}$ or $\bar{SD}$	5.0 ± 0.5	5.0	5.0	ns
t_{su}	Minimum Setup Time, D to CP	5.0 ± 0.5	5.0	5.0	ns
t_h	Minimum Hold Time, D to CP	5.0 ± 0.5	0.0	0.0	ns
t_{rec}	Minimum Recovery Time, $\bar{SD}$ or $\bar{RD}$ to CP	5.0 ± 0.5	3.5	3.5	ns

ORDERING INFORMATION

Device	Package	Shipping [†]
MC74VHCT74AD	SOIC-14	55 Units / Rail
MC74VHCT74ADR2	SOIC-14	2500 / Tape & Reel
MC74VHCT74ADR2G	SOIC-14 (Pb-Free)	2500 / Tape & Reel
MC74VHCT74ADT	TSSOP-14*	96 Units / Rail
MC74VHCT74ADTR2	TSSOP-14*	2500 / Tape & Reel
MC74VHCT74ADTR2G	TSSOP-14*	2500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*This package is inherently Pb-Free.

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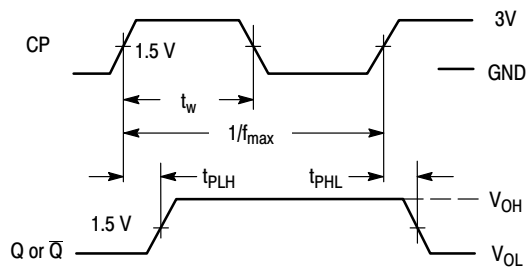


Figure 3. Switching Waveform

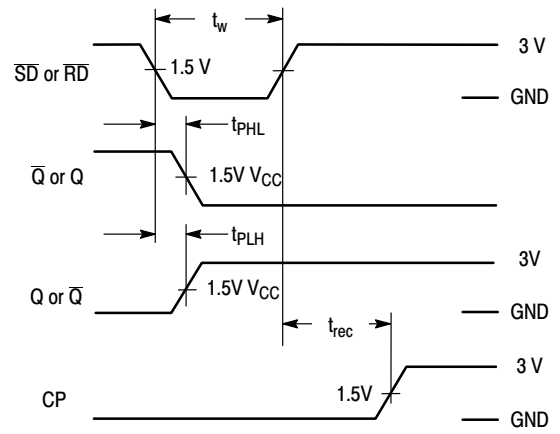


Figure 4. Switching Waveform

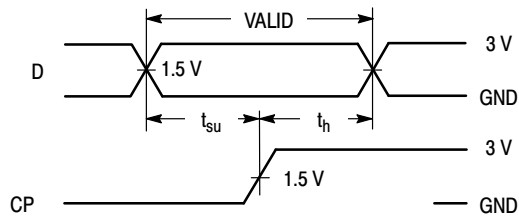
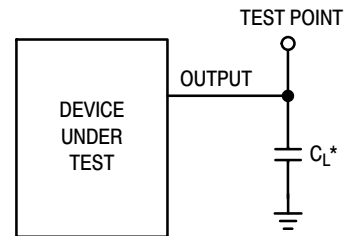


Figure 5. Switching Waveform



*Includes all probe and jig capacitance

Figure 6. Switching Waveform

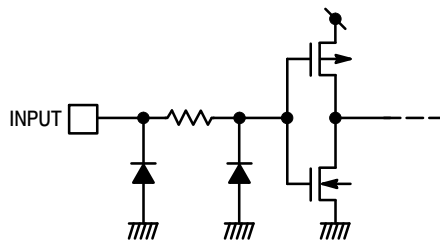
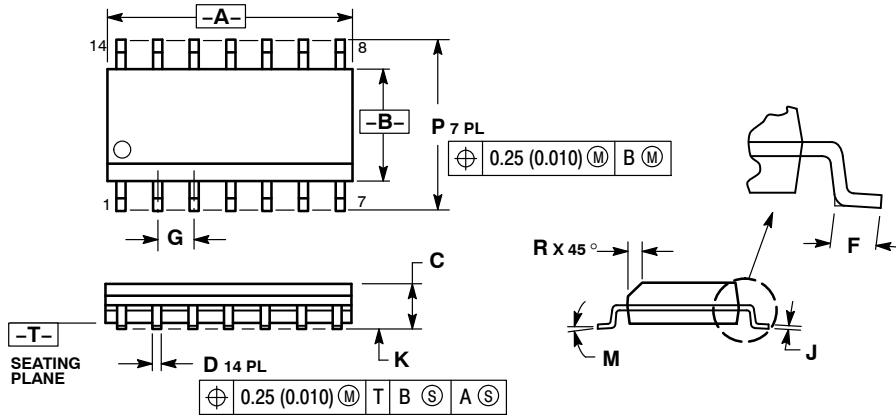


Figure 7. Input Equivalent Circuit

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PACKAGE DIMENSIONS

SOIC-14
D SUFFIX
CASE 751A-03
ISSUE G



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

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